TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSII<sup>-5</sup>)

# 2SK1120

#### DC-DC Converter and Motor Drive Applications

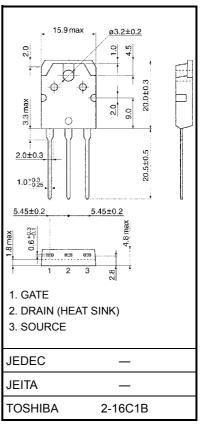
- Low drain-source ON resistance  $: R_{DS} (ON) = 1.5 \Omega (typ.)$
- High forward transfer admittance  $|Y_{fs}| = 4.0 \text{ S (typ.)}$
- Low leakage current  $: I_{DSS} = 300 \ \mu A \ (max) \ (V_{DS} = 800 \ V)$
- Enhancement-mode :  $V_{th} = 1.5 \sim 3.5 \text{ V} (V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA})$

#### Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V <sub>DSS</sub>	1000	V	
Drain-gate voltage (R <sub>GS</sub> = 20 kΩ)		V <sub>DGR</sub>	1000	V	
Gate-source voltage		V <sub>GSS</sub>	±20	V	
Drain current	DC (Note 1)	۱ <sub>D</sub>	8	А	
	Pulse (Note 1)	I <sub>DP</sub>	24	A	
Drain power dissipation (Tc = 25°C)		PD	150	W	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	-55~150	°C	

## **Thermal Characteristics**

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R <sub>th (ch−c)</sub>	0.833	°C / W
Thermal resistance, channel to ambient	R <sub>th (ch−a)</sub>	50	°C / W



Weight: 4.6 g (typ.)

Note 1: Please use devices on condition that the channel temperature is below 150°C.

This transistor is an electrostatic sensitive device. Please handle with caution. Unit: mm

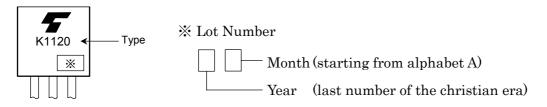
Electrical Characteristics (Ta = 25°C)

Charao	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	$I_{GSS}$ $V_{GS} = \pm 20 V, V_{DS} = 0 V$		_	_	±100	nA
Drain cut-off cu	rain cut-off current $I_{DSS}$ $V_{DS}$ = 800 V, $V_{GS}$ = 0 V		V <sub>DS</sub> = 800 V, V <sub>GS</sub> = 0 V	_	_	300	μA
Drain-source br	eakdown voltage	V (BR) DSS	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	1000		—	V
Gate threshold v	voltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	1.5	_	3.5	V
Drain-source O	N resistance	R <sub>DS (ON)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 4 A	_	1.5	1.8	Ω
Forward transfe	r admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 20 V, I <sub>D</sub> = 4 A	2.0	4.0	—	S
Input capacitance	ce	C <sub>iss</sub>			1300	—	
Reverse transfer capacitance		C <sub>rss</sub>	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz		100	—	pF
Output capacitance		Coss			180	—	
Switching time	Rise time	tr	$V_{GS} \stackrel{10V}{_{0V}} \qquad I_{D} = 4A$ $V_{GS} \stackrel{VOUT}{_{0V}} \qquad I_{D} = 100\Omega$	_	25	_	
	Turn-on time	t <sub>on</sub>		_	40	_	20
	Fall time	t <sub>f</sub>		_	20	_	- ns
	Turn-off time	t <sub>off</sub>	$V_{DD}$ $\Rightarrow$ 400V Duty $\leq$ 1%, t <sub>w</sub> =10 $\mu$ s	_	100	_	
Total gate charge (Gate-source plus gate-drain)		Qg		_	120	_	
Gate-source charge		Q <sub>gs</sub>	V <sub>DD</sub> ≈ 400 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 8 A	_	70	—	nC
Gate-drain ("miller") charge		Q <sub>gd</sub>	] [		50	—	

## Source–Drain Ratings and Characteristics (Ta = 25°C)

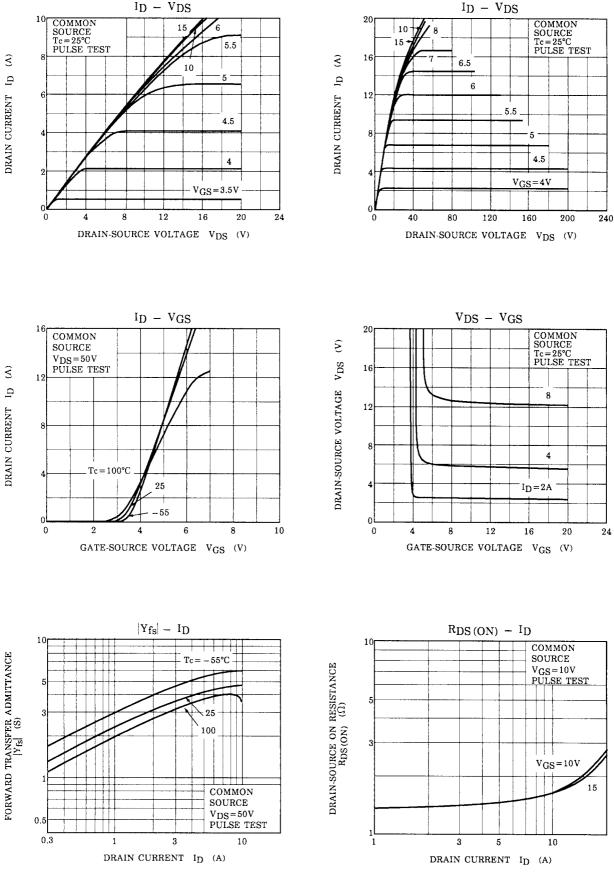
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I <sub>DR</sub>	—	_	_	8	А
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	_	_	_	24	A
Forward voltage (diode)	V <sub>DSF</sub>	I <sub>DR</sub> = 8 A, V <sub>GS</sub> = 0 V	_	_	-1.9	V

# Marking



# TOSHIBA

ΙD



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0

-80

-40

0

40

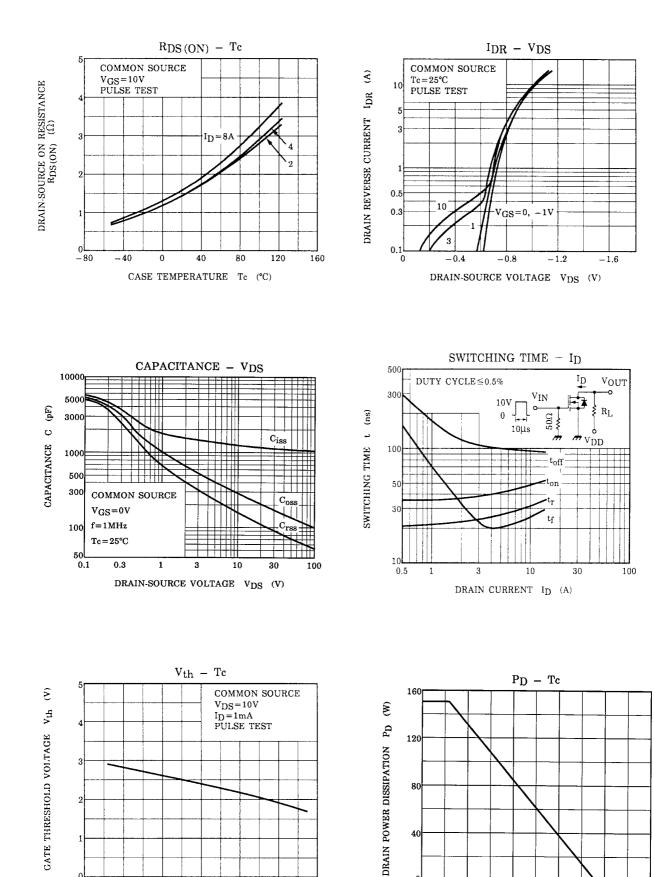
CASE TEMPERATURE Tc (°C)

80

120

160

4



οL

40

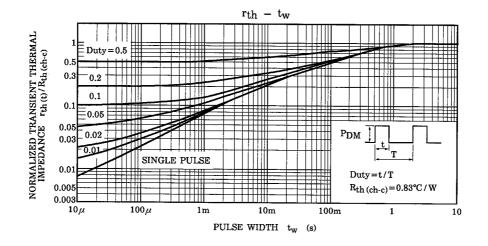
80

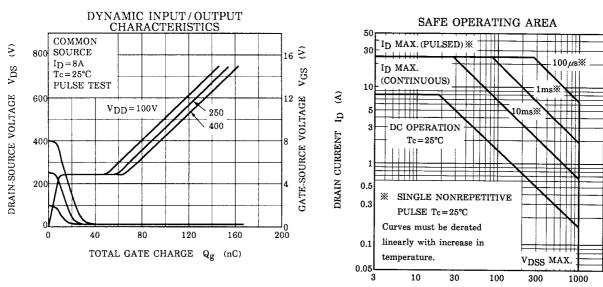
CASE TEMPERATURE Tc (°C)

120

160

200





DRAIN-SOURCE VOLTAGE  $V_{DS}$  (V)

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